

Specification for Approval

Date: 2023/08/29

Customer : _____

TAI-TECH P/N: **APO322530NV-SERIES-HD**

CUSTOMER P/N: _____

DESCRIPTION: _____

QUANTITY: _____ pcs

REMARK:		
Customer Approval Feedback		

西北臺慶科技股份有限公司
TAI-TECH Advanced Electronics Co., Ltd

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Winding Type Chip Inductor

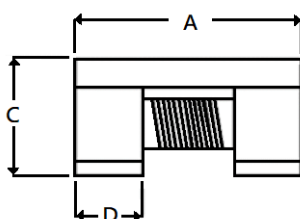
APO322530NV-SERIES-HD

1. Features

1. Ferrite core wire wound construction.
2. High Reliability due to wire wound type construction.
3. Small footprint as well as low profile.
4. 100% Lead(Pb) & Halogen-Free and RoHS compliant.
5. High reliability -Reliability tests comply with AEC-Q200
6. Operating temperature-55~+150°C(Including self - temperature rise)
7. Inductor for use in-vehicle PoC (Power Over Coax)



2. Dimension



Size	A	B	C	D
APO322530	3.20±0.20	2.50±0.20	3.00±0.20	0.58±0.10

Unit:mm



3. Part Numbering



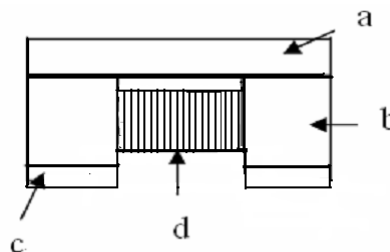
- A: Series
 B: Dimension L x W x H
 C: Application
 D: Category Code V=Vehicle
 E: Inductance 220=22.0uH
 F: Inductance Tolerance M=±20%
 G: Control S/N

4. Specification

Part number	Ls (μH) @100K/0.1V	DCR (Ohm)		SRF typ (MHz)	Isat(mA) Typ					Irms(mA) Typ		
		typ	max		25°C	85°C	105°C	125°C	140°C	25°C	85°C	125°C
APO322530NV-2R2M-HD	2.2±20%	0.10	0.13	300	2200	1900	1700	1500	1300	1900	1730	1000
APO322530NV-6R8M-HD	6.8±20%	0.20	0.24	120	1400	1000	930	800	700	1360	1230	800
APO322530NV-100M-HD	10.0±20%	0.29	0.34	95	1100	850	760	660	560	1130	1020	570
APO322530NV-220M-HD	22.0±20%	0.76	0.88	70	720	580	520	450	390	700	630	400

5. Materials

No.	Description	Specification
a.	Upper plate	Ferrite
b.	Core	Ferrite Core
c.	Termination	Ag/Ni/Sn
d.	Wire	Enameled Copper Wire

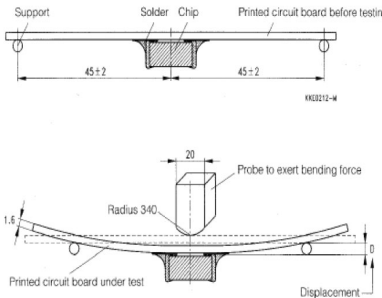
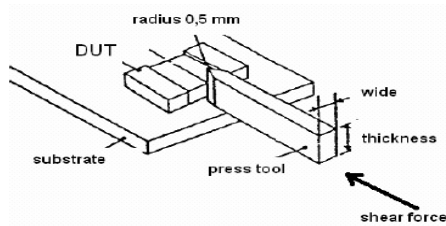


6. Reliability and Test Condition

Item	Performance	Test Condition
Operating temperature	-55~+150°C (Including self - temperature rise)	
Storage temperature	-55~+125°C (on board)	
Electrical Performance Test		
Inductance L	Refer to standard electrical characteristic list	Agilent E4991A , Keysight E4991B ,Keysight 4980AL Agilent-4287, Agilent-4285
SRF		Agilent E4991A , Keysight E4991B
DC Resistance		Agilent-34420A Agilent-4338B
Isat	$\Delta L \leq 30\%$	DC current that causes 30% inductance drop from its initial value at 200 mA at specified temperature.
Irms	Current that causes a 40°C rise at 25°C. Current that causes a 40°C rise at 85°C. Current that causes a 15°C rise at 125°C.	Heat Rated Current (I _{rms}) will cause the coil temperature rise $\Delta T(^{\circ}\text{C})$ without core loss. 1. Applied the allowed DC current. 2. Temperature measured by digital surface thermometer

Reliability Test																	
High Temperature Exposure(Storage) AEC-Q200		Preconditioning: Run through reflow for 3 times.(IPC/JEDEC J-STD-020E Classification Reflow Profiles) Temperature : 150±2°C Duration : 1000hrs Min. Measured at room temperature after placing for 24±4 hrs.															
Temperature Cycling AEC-Q200		Preconditioning: Run through reflow for 3 times.(IPC/JEDEC J-STD-020E Classification Reflow Profiles) Condition for 1 cycle Step1 : -55±2°C 30min Min. Step2 : 150±2°C transition time 1min MAX. Step3 : 150±2°C 30min Min. Step4 : Low temp. Transition time 1min MAX. Number of cycles : 1000 Measured at room temperature after placing for 24±4 hrs.															
Moisture Resistance (AEC-Q200)	Appearance : No damage. Inductance : within±10% of initial value RDC : within ±15% of initial value and shall not exceed the specification value	t=24 hours/cycle. Note: Steps 7a & 7b not required. Unpowered. Measurement at 24±2 hours after test conclusion. 															
Biased Humidity (AEC-Q200)		Preconditioning: Run through reflow for 3 times.(IPC/JEDEC J-STD-020E Classification Reflow Profiles) Humidity : 85±3% R.H, Temperature : 85°C±2°C Duration : 1000hrs Min. Measured at room temperature after placing for 24±4hrs.															
High Temperature Operational Life (AEC-Q200)		Preconditioning: Run through reflow for 3 times.(IPC/JEDEC J-STD-020E Classification Reflow Profiles) Temperature : 150±2°C Duration : 1000hrs Min. with 100% rated current. Measured at room temperature after placing for 24±4hrs.															
External Visual	Appearance : No damage.	Inspect device construction, marking and workmanship. Electrical Test not required.															
Physical Dimension	According to the product specification size measurement	According to the product specification size measurement															
Resistance to Solvents		Add aqueous wash chemical - OKEM clean or equivalent.															
Mechanical Shock	Appearance : No damage. Inductance : within±10% of initial value RDC : within ±15% of initial value and shall not exceed the specification value	<table border="1"> <thead> <tr> <th>Type</th> <th>Peak value (g's)</th> <th>Normal duration (D) (ms)</th> <th>Wave form</th> <th>Velocity change (Vi)ft/sec</th> </tr> </thead> <tbody> <tr> <td>SMD</td> <td>100</td> <td>6</td> <td>Half-sine</td> <td>12.3</td> </tr> <tr> <td>Lead</td> <td>100</td> <td>6</td> <td>Half-sine</td> <td>12.3</td> </tr> </tbody> </table> <p>3 shocks in each direction along 3 perpendicular axes. (18 shocks).</p>	Type	Peak value (g's)	Normal duration (D) (ms)	Wave form	Velocity change (Vi)ft/sec	SMD	100	6	Half-sine	12.3	Lead	100	6	Half-sine	12.3
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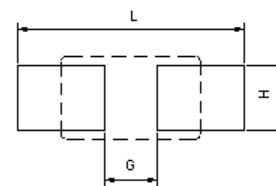
Item	Performance	Test Condition																																																				
Vibration		<p>Preconditioning: Run through reflow for 3 times.(IPC/JEDEC J-STD-020E Classification Reflow Profiles) Oscillation Frequency : 10Hz~2kHz~10Hz for 20 minutes Equipment : Vibration checker Total Amplitude : 5g Testing Time : 12 hours (20 minutes, 12 cycles each of 3 orientations)</p> <p>Test condition :</p> <table border="1"> <thead> <tr> <th>Temperature(°C)</th> <th>Time(s)</th> <th>Temperature ramp/immersion and emersion rate</th> <th>Number of heat cycles</th> </tr> </thead> <tbody> <tr> <td>260 ±5 (solder temp)</td> <td>10 ±1</td> <td>25mm/s ±6 mm/s</td> <td>1</td> </tr> </tbody> </table> <p>Depth: completely cover the termination</p> <p>Continental</p> <p>Table 1: Minimum requirements for lead-free soldering</p> <table border="1"> <thead> <tr> <th>Component Size</th> <th>Ramp up to 150°C</th> <th>T_{min}</th> <th>t_s</th> <th>T_{max}</th> <th>T_L</th> <th>t_c</th> <th>T_{max}*</th> <th>t_d**</th> <th>time 25°C to peak</th> <th>Ramp down</th> </tr> </thead> <tbody> <tr> <td>Thickness < 1.6mm or Thickness 1.6mm-2.5mm and volume < 350 mm³</td> <td>3.0@0.1°C/s</td> <td></td> <td></td> <td></td> <td></td> <td></td> <td>≥260°C</td> <td>≥40s</td> <td></td> <td>6.0@0.1°C/s (The component shall be specified for usage in serial production with up to 6.0°C/s)</td> </tr> <tr> <td>Thickness 1.6mm-2.5mm and volume 300-2000 mm³ or Thickness > 2.5mm and volume < 350 mm³</td> <td>(The component shall be specified for usage in serial production with up to 3.0°C/s)</td> <td>≥190°C</td> <td>≥110s</td> <td>≥200°C</td> <td>≥217°C</td> <td>≥90s</td> <td>≥250°C</td> <td>≥300s</td> <td>≥300s</td> <td></td> </tr> <tr> <td>Thickness 1.6mm-2.5mm and volume > 2500 mm³ or Thickness > 2.5mm and volume > 350 mm³</td> <td></td> <td></td> <td></td> <td></td> <td></td> <td></td> <td>≥245°C</td> <td></td> <td></td> <td></td> </tr> </tbody> </table> <p>*peak temperature is measured on the centre top of the component package ** t_p measured @ T_{peak}-5°C</p>	Temperature(°C)	Time(s)	Temperature ramp/immersion and emersion rate	Number of heat cycles	260 ±5 (solder temp)	10 ±1	25mm/s ±6 mm/s	1	Component Size	Ramp up to 150°C	T _{min}	t _s	T _{max}	T _L	t _c	T _{max} *	t _d **	time 25°C to peak	Ramp down	Thickness < 1.6mm or Thickness 1.6mm-2.5mm and volume < 350 mm ³	3.0@0.1°C/s						≥260°C	≥40s		6.0@0.1°C/s (The component shall be specified for usage in serial production with up to 6.0°C/s)	Thickness 1.6mm-2.5mm and volume 300-2000 mm ³ or Thickness > 2.5mm and volume < 350 mm ³	(The component shall be specified for usage in serial production with up to 3.0°C/s)	≥190°C	≥110s	≥200°C	≥217°C	≥90s	≥250°C	≥300s	≥300s		Thickness 1.6mm-2.5mm and volume > 2500 mm ³ or Thickness > 2.5mm and volume > 350 mm ³							≥245°C			
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Thermal shock (AEC-Q200)		<p>Preconditioning: Run through reflow for 3 times.(IPC/JEDEC J-STD-020E Classification Reflow Profiles) Condition for 1 cycle Step1 : -55±2°C 15±1min Step2 : 150±2°C within 20Sec. Step3 : 150±2°C 15±1min Number of cycles : 300 Measured at room temperature after placing for 24±4hrs.</p>																																																				
ESD	<p>Appearance : No damage. Inductance : within±10% of initial value RDC : within ±15% of initial value and shall not exceed the specification value</p>	<p>Direct Contact and Air Discharge PASSIVE COMPONENT HBM ESD Discharge Waveform to a Coaxial Target Test method: AEC-Q200-002 Test mode : Contact Discharge Discharge level : 4 KV (Level: 2)</p>																																																				
Solderability	More than 95% of the terminal electrode should be covered with solder	<p>a. Method B, 4hrs @155°C dry heat @235°C±5°C Testing Time : 5 +0/-0.5 seconds b. Method D category 3. (8hours ± 15 min)@ 260°C±5°C Testing Time : 30 +0/-0.5 seconds</p>																																																				
Electrical Characterization	Refer Specification for Approval	Summary to show Min, Max, Mean and Standard deviation.																																																				
Flammability	Electrical Test not required.	V-0 or V-1 are acceptable.																																																				

Item	Performance	Test Condition
Board Flex	Appearance : No damage. Inductance : within $\pm 10\%$ of initial value RDC : within $\pm 15\%$ of initial value and shall not exceed the specification value	Preconditioning: Run through reflow for 3 times. (IPC/JEDEC J-STD-020E Classification Reflow Profiles) Place the 100mm X 40mm board into a fixture similar to the one shown in below Figure with the component facing down. The apparatus shall consist of mechanical means to apply a force which will bend the board (D) x 2 mm minimum. The duration of the applied forces shall be 60 (+ 5) sec. The force is to be applied only once to the board. 
Terminal Strength(SMD)	Appearance : No damage. Inductance : within $\pm 10\%$ of initial value RDC : within $\pm 15\%$ of initial value and shall not exceed the specification value	Preconditioning: Run through reflow for 3 times. (IPC/JEDEC J-STD-020E Classification Reflow Profiles) With the component mounted on a PCB with the device to be tested, apply a 17.7 N (1.8 Kg) force to the side of a device being tested. This force shall be applied for 60 +1 seconds. Also the force shall be applied gradually as not to apply a shock to the component being tested. 

7. Soldering and Mounting

7-1. Recommended PC Board Pattern

Land Patterns For Reflow Soldering								
Series	Type	A(mm)	B(mm)	C(mm)	D(mm)	L(mm)	G(mm)	H(mm)
APO	322530	3.20±0.20	2.50±0.20	3.0±0.2.0	0.58±0.10.	3.80	2.20	2.80



7-2. Soldering

Mildly activated rosin fluxes are preferred. TAI-TECH terminations are suitable for re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

7-2.1 Soldering Reflow:

Recommended temperature profiles for lead free re-flow soldering in Figure 1. Table 1.1&1.2 (J-STD-020E)

7-2.2 Soldering Iron:

Products attachment with a soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended. (Figure 2.)

- Preheat circuit and products to 150°C
- Never contact the ceramic with the iron tip
- Use a 20 watt soldering iron with tip diameter of 1.0mm
- 350°C tip temperature (max)
- 1.0mm tip diameter (max)
- Limit soldering time to 4-5sec.

Fig.1 Soldering Reflow

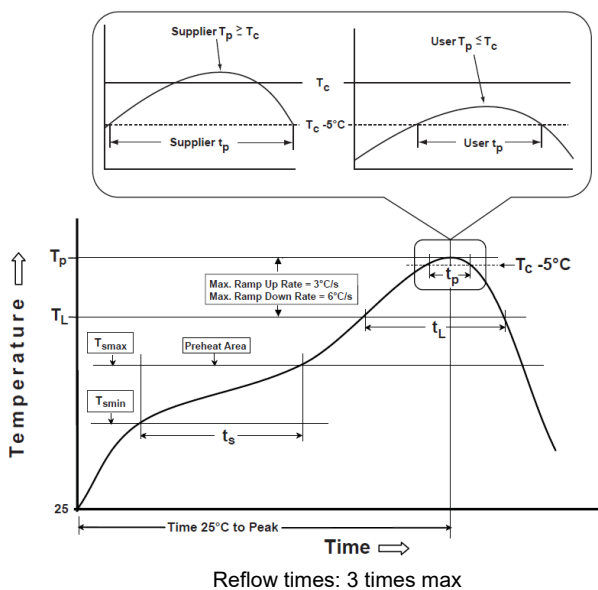


Fig.2 Iron soldering temperature profiles

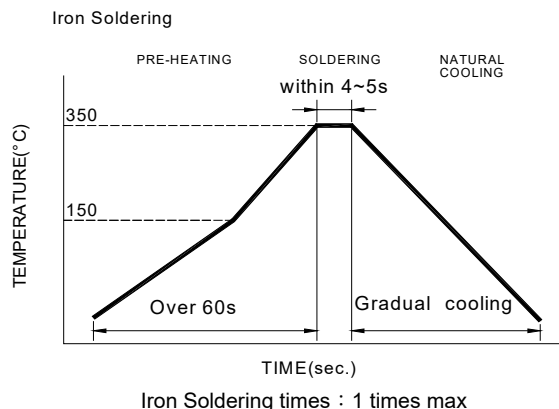


Table (1.1): Reflow Profiles

Profile Type:	Pb-Free Assembly
Preheat -Temperature Min(T_{smin}) -Temperature Max(T_{smax}) -Time(t_s)from(T_{smin} to T_{smax})	150°C 200°C 60-120seconds
Ramp-up rate(T_L to T_p)	3°C/second max.
Liquidus temperature(T_L) Time(t_L)maintained above T_L	217°C 60-150 seconds
Classification temperature(T_c)	See Table (1.2)
Time(t_p) at $T_c - 5^\circ\text{C}$ (T_p should be equal to or less than T_c .)	< 30 seconds
Ramp-down rate(T_p to T_L)	6°C /second max.
Time 25°C to peak temperature	8 minutes max.

T_p : maximum peak package body temperature, T_c : the classification temperature.

For user (customer) T_p should be equal to or less than T_c .

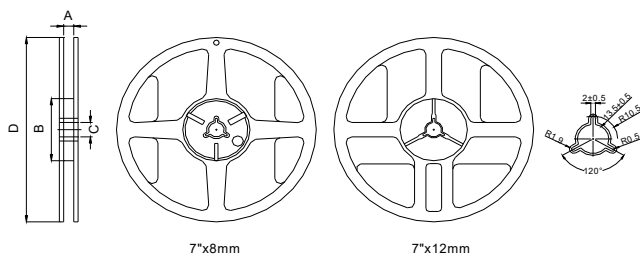
Table (1.2) Package Thickness/Volume and Classification Temperature (T_c)

	Package Thickness	Volume mm ³ <350	Volume mm ³ 350-2000	Volume mm ³ >2000
PB-Free Assembly	<1.6mm	260°C	260°C	260°C
	1.6-2.5mm	260°C	250°C	245°C
	≥2.5mm	250°C	245°C	245°C

Reflow is referred to standard IPC/JEDEC J-STD-020E ◦

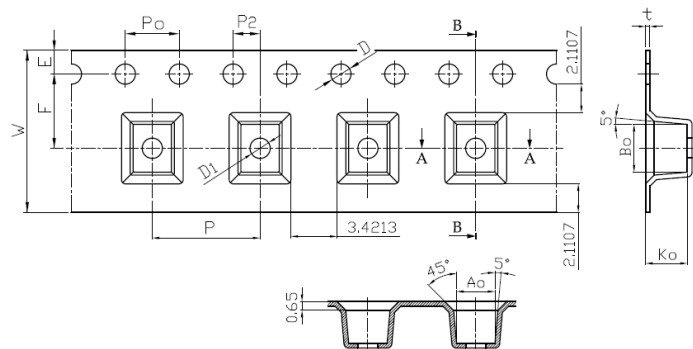
8. Packaging Information

8-1. Reel Dimension



Type	A(mm)	B(mm)	C(mm)	D(mm)
7"x12mm	13.5±0.5	60.0±2.0	13.5±0.5	178.0±2.0

8-2. Tape Dimension / 12mm

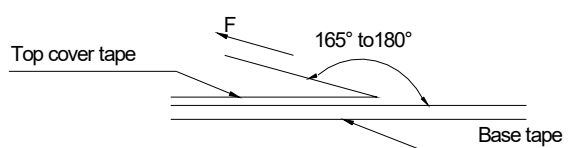


Series	Size	W(mm)	P(mm)	E(mm)	F(mm)	P2(mm)	D(mm)	D1(mm)	Po(mm)	Ao(mm)	Bo(mm)	Ko(mm)	t(mm)
APO	322530	12.00±0.3	8.00±0.1	1.75±0.1	5.50±0.1	2.00±0.1	1.5+0.1/-0	1.5±0.10	4.00±0.1	2.85±0.1	3.55±0.1	3.10±0.1	0.35±0.05

8-3. Packaging Quantity

Chip size	Chip / Reel	Inner box	Middle box	Carton
APO322530N	500	2000	10000	20000

8-4. Tearing Off Force



The force for tearing off cover tape is 15 to 80 grams in the arrow direction under the following conditions.

Room Temp. (°C)	Room Humidity (%)	Room atm (hPa)	Tearing Speed mm/min
5~35	45~85	860~1060	300

Application Notice

- Storage Conditions(component level)

To maintain the solderability of terminal electrodes:

 - TAI-TECH products meet IPC/JEDEC J-STD-020E standard-MSL, level 1.
 - Temperature and humidity conditions: Less than 40°C and 60% RH.
 - Recommended products should be used within 12 months form the time of delivery.
 - The packaging material should be kept where no chlorine or sulfur exists in the air.
- Transportation
 - Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
 - The use of tweezers or vacuum pick up is strongly recommended for individual components.
 - Bulk handling should ensure that abrasion and mechanical shock are minimized.



測試報告 Test Report

號碼(No.): ETR23302694

日期(Date): 17-Mar-2023

頁數(Page): 1 of 15

西北臺慶科技股份有限公司 (TAI-TECH ADVANCED ELECTRONICS CO., LTD.)
臺慶精密電子(昆山)有限公司 (TAI-TECH ADVANCED ELECTRONICS (KUN-SHAN) CO. LTD.)
慶邦電子元件(泗洪)有限公司 (TAIPAQ ELECTRONICS (SI-HONG) CO., LTD.)
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江蘇省昆山市蓬朗昆嘉高科技工業區郭澤路 (GUO-ZE ROAD, KUNJIA HI-TECH INDUSTRIAL PARK, KUN-SHAN, JIANG-SU, CHINA)
中國·江蘇省·宿遷市·泗洪縣·經濟開發區杭州路南側·建設北路東側 (THE SOUTH HANGZHOU ROAD AND THE EAST JIANSHE ROAD·ECONOMIC DEVELOPMENT ZONE·SIHONG COUNTY·SUQIANCITY·JIANGSU PROVINCE·P,R·CHINA)


以下測試樣品係由申請廠商所提供及確認 (The following sample(s) was/were submitted and identified by the applicant as) :

樣品名稱(Sample Name) : WIREWOUND SERIES
樣品型號(Style/Item No.) : WCM(YCW) · WCL · HSF · HDMI · DVI · BCM · PCM · TCM · LCM · LPF · TXF · ACM · DCM(YLW) · WIH · BPH · TNH · YCM · STF · APO · QLL · FGO · APOC · TLAN SERIES

=====
收件日(Sample Receiving Date) : 10-Mar-2023
測試期間(Testing Period) : 10-Mar-2023 to 17-Mar-2023

測試需求(Test Requested) : 依據客戶要求進行測試·測試項目請參閱測試結果表格。(Testing item(s) is/are specified by client. Please refer to result table for testing item(s).)

測試結果(Test Results) : 請參閱下一頁 (Please refer to following pages.)


Troy Chang / Department Manager
Signed for and on behalf of
SGS TAIWAN LTD.
Chemical Laboratory - Taipei



PIN CODE: 6621A826

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測試報告

Test Report

號碼(No.): ETR23302694

日期(Date): 17-Mar-2023

頁數(Page): 2 of 15

西北臺慶科技股份有限公司 (TAI-TECH ADVANCED ELECTRONICS CO., LTD.)

臺慶精密電子(昆山)有限公司 (TAI-TECH ADVANCED ELECTRONICS (KUN-SHAN) CO. LTD.)

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測試部位敘述 (Test Part Description)

No.1 : 整體混測 (MIXED ALL PARTS)

測試結果 (Test Results)

測試項目 (Test Items)	測試方法 (Method)	單位 (Unit)	MDL	結果 (Result)
				No.1
鎘 (Cd) (Cadmium (Cd))	參考IEC 62321-5: 2013 · 以感應耦合電漿發射光譜儀分析。(With reference to IEC 62321-5: 2013, analysis was performed by ICP-OES.)	mg/kg	2	n.d.
鉛 (Pb) (Lead (Pb))	參考IEC 62321-5: 2013 · 以感應耦合電漿發射光譜儀分析。(With reference to IEC 62321-5: 2013, analysis was performed by ICP-OES.)	mg/kg	2	n.d.
汞 (Hg) (Mercury (Hg))	參考IEC 62321-4: 2013+ AMD1: 2017 · 以感應耦合電漿發射光譜儀分析。(With reference to IEC 62321-4: 2013+ AMD1: 2017, analysis was performed by ICP-OES.)	mg/kg	2	n.d.
六價鉻 Cr(VI) (Hexavalent Chromium Cr(VI))	參考IEC 62321-7-2: 2017 · 以紫外光-可見光分光光度計分析。(With reference to IEC 62321-7-2: 2017, analysis was performed by UV-VIS.)	mg/kg	8	n.d.

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測試報告

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測試項目 (Test Items)	測試方法 (Method)	單位 (Unit)	MDL	結果 (Result)
				No.1
一溴聯苯 (Monobromobiphenyl)	參考IEC 62321-6: 2015 · 以氣相層析儀/質譜儀分析。(With reference to IEC 62321-6: 2015, analysis was performed by GC/MS.)	mg/kg	5	n.d.
二溴聯苯 (Dibromobiphenyl)		mg/kg	5	n.d.
三溴聯苯 (Tribromobiphenyl)		mg/kg	5	n.d.
四溴聯苯 (Tetrabromobiphenyl)		mg/kg	5	n.d.
五溴聯苯 (Pentabromobiphenyl)		mg/kg	5	n.d.
六溴聯苯 (Hexabromobiphenyl)		mg/kg	5	n.d.
七溴聯苯 (Heptabromobiphenyl)		mg/kg	5	n.d.
八溴聯苯 (Octabromobiphenyl)		mg/kg	5	n.d.
九溴聯苯 (Nonabromobiphenyl)		mg/kg	5	n.d.
十溴聯苯 (Decabromobiphenyl)		mg/kg	5	n.d.
多溴聯苯總和 (Sum of PBBs)		mg/kg	-	n.d.
一溴聯苯醚 (Monobromodiphenyl ether)		mg/kg	5	n.d.
二溴聯苯醚 (Dibromodiphenyl ether)		mg/kg	5	n.d.
三溴聯苯醚 (Tribromodiphenyl ether)		mg/kg	5	n.d.
四溴聯苯醚 (Tetrabromodiphenyl ether)		mg/kg	5	n.d.
五溴聯苯醚 (Pentabromodiphenyl ether)		mg/kg	5	n.d.
六溴聯苯醚 (Hexabromodiphenyl ether)		mg/kg	5	n.d.
七溴聯苯醚 (Heptabromodiphenyl ether)		mg/kg	5	n.d.
八溴聯苯醚 (Octabromodiphenyl ether)		mg/kg	5	n.d.
九溴聯苯醚 (Nonabromodiphenyl ether)		mg/kg	5	n.d.
十溴聯苯醚 (Decabromodiphenyl ether)		mg/kg	5	n.d.
多溴聯苯醚總和 (Sum of PBDEs)		mg/kg	-	n.d.

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測試項目 (Test Items)	測試方法 (Method)	單位 (Unit)	MDL	結果 (Result)
				No.1
鄰苯二甲酸丁苯甲酯 (BBP) (Butyl benzyl phthalate (BBP))	參考IEC 62321-8: 2017, 以氣相層析儀/質譜儀分析。(With reference to IEC 62321-8: 2017, analysis was performed by GC/MS.)	mg/kg	50	n.d.
鄰苯二甲酸二丁酯 (DBP) (Dibutyl phthalate (DBP))		mg/kg	50	n.d.
鄰苯二甲酸二(2-乙基己基)酯 (DEHP) (Di-(2-ethylhexyl) phthalate (DEHP))		mg/kg	50	n.d.
鄰苯二甲酸二異丁酯 (DIBP) (Diisobutyl phthalate (DIBP))		mg/kg	50	n.d.
鄰苯二甲酸二異癸酯 (DIDP) (Diisodecyl phthalate (DIDP)) (CAS No.: 26761-40-0, 68515-49-1)		mg/kg	50	n.d.
鄰苯二甲酸二異壬酯 (DINP) (Diisononyl phthalate (DINP)) (CAS No.: 28553-12-0, 68515-48-0)		mg/kg	50	n.d.
鄰苯二甲酸二正辛酯 (DNOP) (Di-n-octyl phthalate (DNOP)) (CAS No.: 117-84-0)		mg/kg	50	n.d.
鄰苯二甲酸二正戊酯 (DNPP) (Di-n-pentyl phthalate (DNPP)) (CAS No.: 131-18-0)		mg/kg	50	n.d.
鄰苯二甲酸二正己酯 (DNHP) (Di-n-hexyl phthalate (DNHP)) (CAS No.: 84-75-3)		mg/kg	50	n.d.

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測試項目 (Test Items)	測試方法 (Method)	單位 (Unit)	MDL	結果 (Result)
				No.1
六溴環十二烷及所有主要被辨別出的異構物(HBCDD) (α- HBCDD, β- HBCDD, γ- HBCDD) (Hexabromocyclododecane (HBCDD) and all major diastereoisomers identified (α- HBCDD, β- HBCDD, γ- HBCDD)) (CAS No.: 25637-99-4, 3194-55-6 (134237-51-7, 134237-50-6, 134237-52-8))	參考IEC 62321-9: 2021 · 以氣相層析儀/質譜儀分析。(With reference to IEC 62321-9: 2021, analysis was performed by GC/MS.)	mg/kg	20	n.d.
氟 (F) (Fluorine (F)) (CAS No.: 14762-94-8)	參考BS EN 14582: 2016 · 以離子層析儀分析。(With reference to BS EN 14582: 2016, analysis was performed by IC.)	mg/kg	50	n.d.
氯 (Cl) (Chlorine (Cl)) (CAS No.: 22537-15-1)		mg/kg	50	n.d.
溴 (Br) (Bromine (Br)) (CAS No.: 10097-32-2)		mg/kg	50	n.d.
碘 (I) (Iodine (I)) (CAS No.: 14362-44-8)		mg/kg	50	n.d.
全氟辛烷磺酸及其鹽類 (PFOS and its salts) (CAS No.: 1763-23-1 and its salts)	參考CEN/TS 15968: 2010 · 以液相層析串聯質譜儀分析。(With reference to CEN/TS 15968: 2010, analysis was performed by LC/MS/MS.)	mg/kg	0.01	n.d.
全氟辛酸及其鹽類 (PFOA and its salts) (CAS No.: 335-67-1 and its salts)		mg/kg	0.01	n.d.
銻 (Sb) (Antimony (Sb)) (CAS No.: 7440-36-0)	參考US EPA 3052: 1996 · 以感應耦合電漿發射光譜儀分析。(With reference to US EPA 3052: 1996, analysis was performed by ICP-OES.)	mg/kg	2	82.3
鈹 (Be) (Beryllium (Be)) (CAS No.: 7440-41-7)		mg/kg	2	n.d.

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測試項目 (Test Items)	測試方法 (Method)	單位 (Unit)	MDL	結果 (Result)
				No.1
聚氯乙烯 (Polyvinyl chloride) (PVC)	參考ASTM E1252: 2021 · 以傅立葉轉換紅外線光譜儀及焰色法分析。(With reference to ASTM E1252: 2021, analysis was performed by FT-IR and Flame Test.)	**	-	Negative

備註(Note) :

1. mg/kg = ppm ; 0.1wt% = 0.1% = 1000ppm
2. MDL = Method Detection Limit (方法偵測極限值)
3. n.d. = Not Detected (未檢出) ; 小於MDL / Less than MDL
4. "-" = Not Regulated (無規格值)
5. ** = Qualitative analysis (No Unit) 定性分析(無單位)
6. Negative = Undetectable 陰性(未偵測到); Positive = Detectable 陽性(已偵測到)
7. 全氟辛烷磺酸及其鹽類包含等物質 (PFOS and its salts including) :
CAS No.: 1763-23-1, 2795-39-3, 29457-72-5, 29081-56-9, 70225-14-8, 56773-42-3, 251099-16-8, 307-35-7, 91036-71-4, 4021-47-0 and others.
8. 全氟辛酸及其鹽類包含等物質 (PFOA and its salts including) :
CAS No.: 335-67-1, 335-95-5, 2395-00-8, 335-93-3, 335-66-0, 3825-26-1 and others.
9. 樣品的測試是基於申請人要求混合測試 · 報告中的混合測試結果不代表其中個別單一材質的含量。
The sample(s) was/were analyzed on behalf of the applicant as mixing sample in one testing. The above result(s) was/were only given as the informality value.

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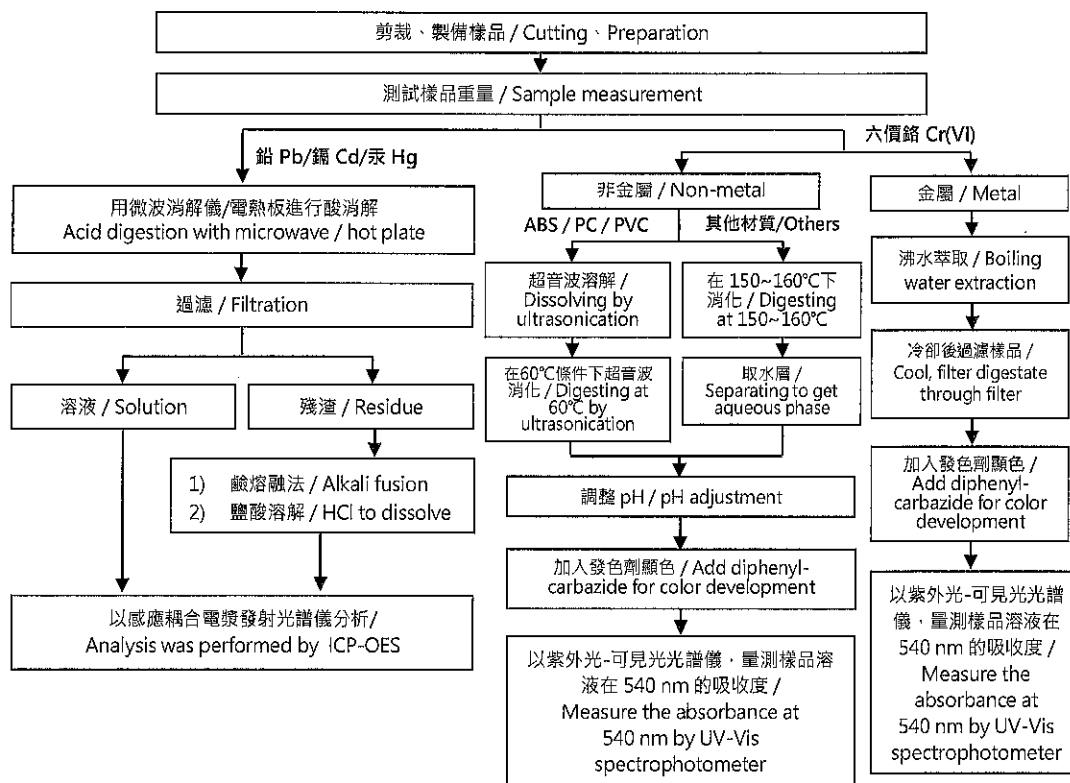
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重金屬流程圖 / Analytical flow chart of heavy metal

根據以下的流程圖之條件，樣品已完全溶解。(六價鉻測試方法除外)

These samples were dissolved totally by pre-conditioning method according to below flow chart.

(Cr⁶⁺ test method excluded)



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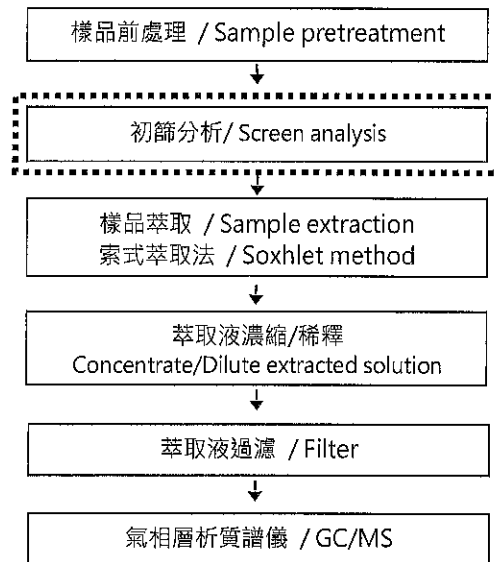
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多溴聯苯/多溴聯苯醌分析流程圖 / Analytical flow chart - PBBs/PBDEs

- 初次測試程序 / First testing process ———→
- 選擇性篩檢程序 / Optional screen process ·····→
- 確認程序 / Confirmation process - - - ->



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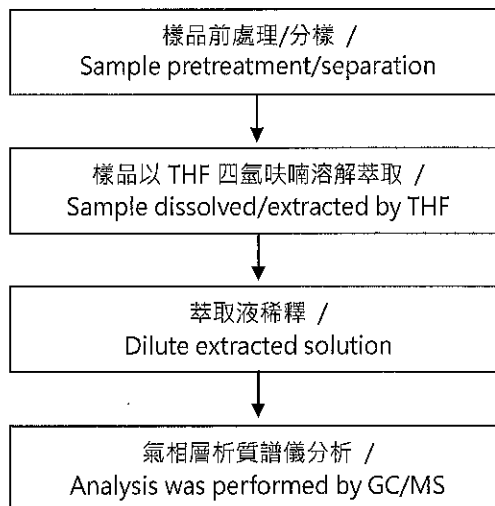
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可塑劑分析流程圖 / Analytical flow chart - Phthalate

【測試方法/Test method: IEC 62321-8】



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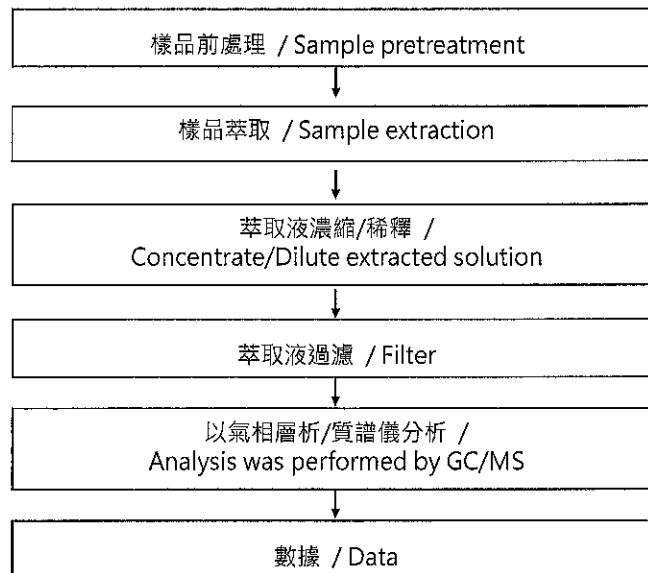
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六溴環十二烷分析流程圖 / Analytical flow chart - HBCDD



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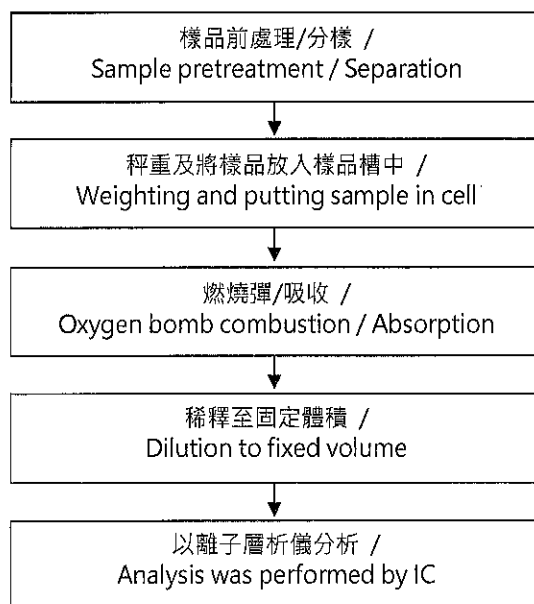
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鹵素分析流程圖 / Analytical flow chart - Halogen



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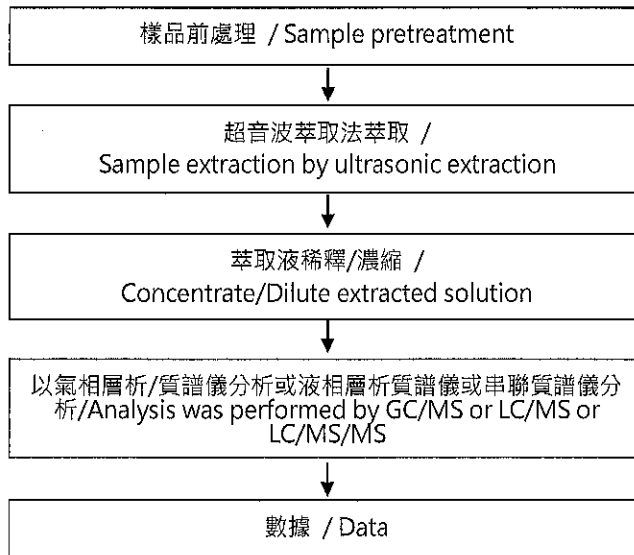
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全氟化合物(包含全氟辛酸/全氟辛烷磺酸/其相關化合物等等)分析流程圖 / Analytical flow chart – PFAS (including PFOA/PFOS/its related compound, etc.)



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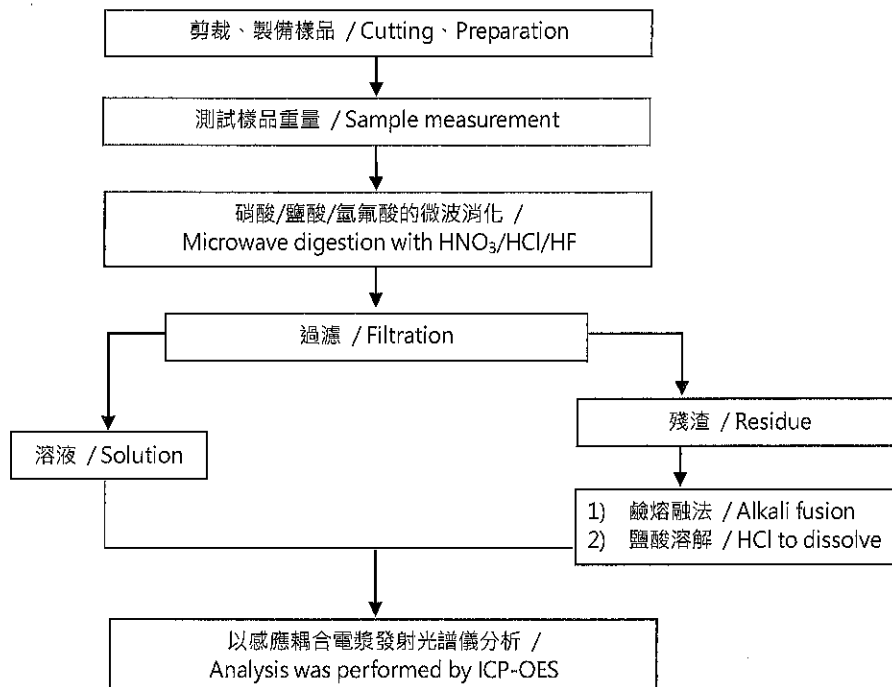
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元素(含重金屬)分析流程圖 / Analytical flow chart of elements (Heavy metal included)

根據以下的流程圖之條件·樣品已完全溶解·

These samples were dissolved totally by pre-conditioning method according to below flow chart.

【參考方法/Reference method : US EPA 3051A · US EPA 3052】



* US EPA 3051A 方法未添加氫氟酸 / US EPA 3051A method does not add HF.

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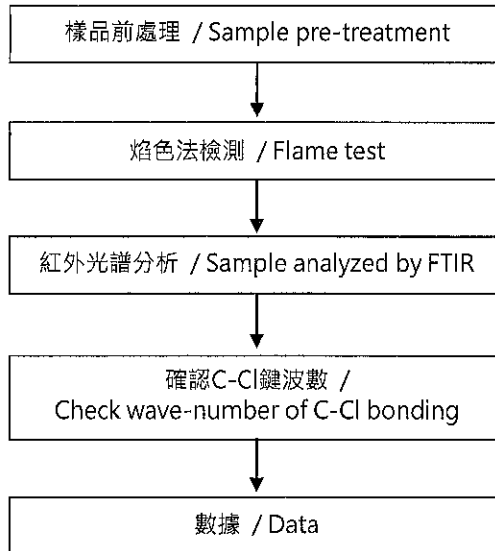
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聚氯乙炔物質判定分析流程圖 / Analysis flow chart - PVC



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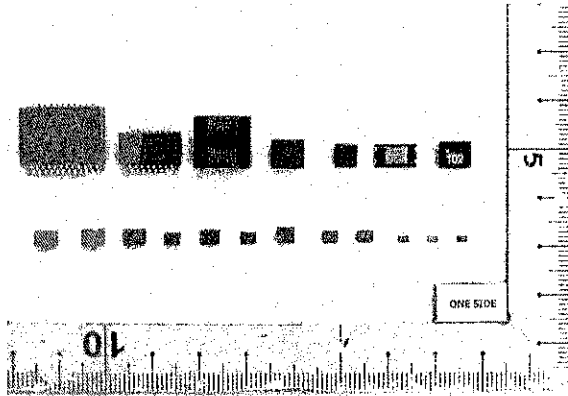
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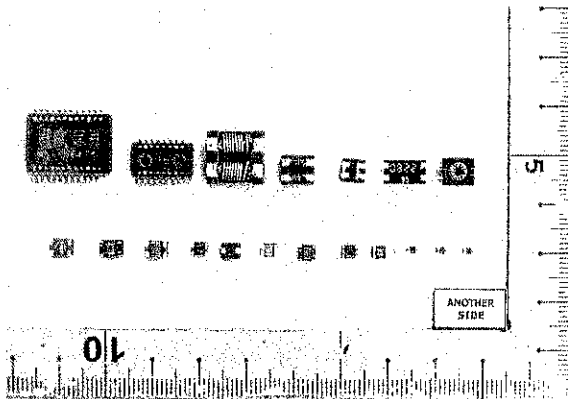
* 照片中如有箭頭標示，則表示為實際檢測之樣品/部位。*

(The tested sample / part is marked by an arrow if it's shown on the photo.)

ETR23302694



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